n	11-12-1	998	Docket No.: PRSS-0003-US			
FORM PTO-1595 (Modified) (Rev. 6-93) OMB No. 0651-0011 (exp.4/94) Copyright 1996-97 LegalStar			U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office			
FOBA/REV02 Tab settings $\Rightarrow \Rightarrow \Rightarrow \bigtriangledown \qquad \qquad \bigtriangledown$	1008766	517	▼	//~	9	- 98
To the Honorable Commissioner of Patents	and Trademarks: F	Please record the	ne attached orig	ginal documents o	r copy f	thereof.
1. Name of conveying party(ies): Ting-wah Wong		 2. Name and address of receiving party(ies): Name: Programmable Silicon Solutions Address: 628 A E. Evelyn 				
Additional names(s) of conveying party(ies)	Yes 🛛 No				<u> </u>	
3. Nature of conveyance:						
🛛 Assignment 🗌 Merg	ger					
□ Security Agreement □ Cha	nge of Name	City: <u>Sunny</u>	vale	State/Pro	ov.: <u>CA</u>	
Other		Country: <u>U.S.</u> ZIP: <u>94086</u>				
Execution Date: October 23, 1998		Additional name	(s) & address(es)	🗆 Yes	X N	0
	Additional numbers	Yes 2	SI No			
 5. Name and address of party to whom correspondence concerning document should be mailed: Name: <u>Timothy N. Trop</u> Registration No. <u>28,994</u> Address: <u>Trop, Pruner, Hu & Miles, P.C.</u> 		6. Total number of applications and patents involved:				
		7. Total fee (3	7 CFR 3.41):	\$ 40.00		
		Enclosed - Any excess or insufficiency should be credited or debited to deposit account				
8554 Katy Freeway, Suite 100			ed to be charg	ed to deposit acco	ount	
City: <u>Houston</u> State/Pro Country: <u>United States</u> ZIP: 770	8. Deposit account number:					
	DO NOT US	SE THIS SPACE		*000000		
9. Statement and signature. To the best of my knowledge and belief, the of the original document. <u>Timothy N. Trop</u> Name of Person Signing	A	Signature	2	5		сору
	er of pages including co	ver sneet, attacht		ATENT		

REEL: 9567 FRAME: 0783

ASSIGNMENT

WHEREAS, I, TING-WAH WONG, am the sole inventor of an application for United States Letters Patent Serial No. 08/838,854, filed April 11, 1997 titled, NONVOLATILE MEMORY CAPABLE OF USING SUBSTRATE HOT ELECTRON INJECTION, and

WHEREAS, PROGRAMMABLE SILICON SOLUTIONS, a corporation created and existing under and by virtue of the laws of the State of California, is desirous of acquiring the entire right, title and interest in and to the aforesaid invention throughout the world, and all right, title and interest in, to and under any and all Letters Patent of the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell, assign, transfer and set over to PROGRAMMABLE SILICON SOLUTIONS, all right, title and interest in and to the said invention throughout the world, and said application for U.S. Letters Patent, and any and all divisions, continuations, and reissues thereof, and any and all Letters Patent of the United States and foreign countries which may be granted therefor, the same to be held and enjoyed by PROGRAMMABLE SILICON SOLUTIONS for its own use and benefit, and for the use and benefit of its successors, assigns, or other legal representatives, to the end of the term or terms for which said Letters Patent of the United States or foreign countries are or may be granted or reissued, as fully and entirely as the same would have been held and enjoyed by me if this assignment and sale had not been made.

And I hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all Letters Patent of the United States on said invention or resulting from said application and from any and all divisions, continuations, and reissues thereof, to PROGRAMMABLE SILICON SOLUTIONS, as assignee of our entire interest, and hereby covenant that I have the full right to convey the entire interest herein assigned, and that I have not executed and will not execute any agreement in conflict herewith.

And I further hereby covenant and agree that I will, at any time, upon request, execute and deliver any and all papers that may be necessary or desirable to perfect the title of said invention and to such Letters Patent as may be granted therefor, to PROGRAMMABLE SILICON SOLUTIONS, its successors, assigns, or other legal representatives and that if PROGRAMMABLE SILICON SOLUTIONS, its successors, assigns or other legal representatives shall desire to file any divisional or continuation applications or to secure a reissue of such Letters Patent, or to file a disclaimer relating thereto, will upon request, sign all papers, make all rightful oaths and do all lawful acts requisite for the filing of such divisional or continuation application, or such application for reissue and the procuring thereof, and for the filing of such disclaimer, without further compensation but at the expense of said assignee, its successors, or other legal representatives.

And I do further covenant and agree that I will, at any time upon request, communicate to PROGRAMMABLE SILICON SOLUTIONS, its successors, assigns or

other legal representatives, such facts relating to said invention and Letters Patent or the file history thereof as may be known to me, and testify as to the same in any interference or other litigation when requested so to do, without further compensation but at the expense of said assignee, its successors, or other legal representatives.

EXECUTED THIS 23 day of October, 1998.

1.Ume1 Name: TI

PRSS-0003-US